ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® OCOPYRIGH 2005. I international and Par	PC Bannockl	ourn Illinois A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su	bstances v all lower	vithin the manufactu level materials for v	urer listed which the	item. Note: it manufacturer	the item is an as has engineering	sembly with low responsibility.	
				Form Type Distribute	*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and					Afg Informati	on		
upplier Information														
company name*	Company un	Company unique ID			Unique ID Authority				Respon	Response Date*				
onsemi										2023-0	2023-06-08			
ontact Name Title - Contact					Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Enviro Co			o Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representati			ntative		Phone - Representative*			Email	Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		ber Mfr Item Name			Effective Date	Version	on Manufacturing Site			Weight*	UOM	Unit Type	
	CAT240	CAT24C16C5ATR 16KB I2C SER EEI		EEPROM		2023-06-08		C	CNQ		0.479711	mg	Each	
Ianufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Alloy		J-STD-020 MSI	L Rating Peak Process Body Temperature Max Time			e Max Time at Peal	eak Temperature Number of Reflow Cycles						
SnAgCu CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperatu	ire during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless	cable [E] enter the weigh	, Requester or Supplier) [B it of the substance or the P]] select the substance of the substance	ance category (JIG or Requester) or [F] Optionally enter the positive (+	enter a value (Supplier). [C] selec -) and negative (-) tolerance in per	et the substance (J cent (Note: percer	IG) or enter the substa at tolerance values are	nce and CAS (Other). [D] expected to cover a 3
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.3895	mg	Supplier	Silicon (Si)	7440-21-3		0.3895	mg
Insulating Layer	0.0105	mg		Polyimide	proprietary data		0.0105	mg
RDL	0.009463	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0094	mg
Solder Ball	0.06531	mg	Supplier	Silver (Ag)	7440-22-4		0.0017	mg
			Supplier	Tin (Sn)	7440-31-5		0.0632	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg
Under Bump Metal	0.004938	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0049	mg